## TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

Title of Invention	METHOD OF FABRICATING A SEMICONDUCTOR DEVICE	
Application Number :		
Date :		
First Named Applica	nt: Jui-Tsen Huang	
Confirmation Number:		
Attacas Desired Nove	phor: NATIDA97USA1	

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Submitted By:	Elec. Sign.
Winston Hsu	Winston Hsu
Registered Number: 41,526	

Doguments being submitted:	Files
Documents being submitted:	riies
us-request	NAUP0487-1-usrequ.xml
us request	us-request.dtd
	us-request.xsl
us-fee-sheet	NAUP0487-1-usfees.xml
30 100 0/100	us-fee-sheet.xsl
	us-fee-sheet.dtd
us-declaration	NAUP0487-1ASS1.tif
application-body	NAUP0487-1-trans.xml
application body	us-application-body.xsl
	application-body.dtd
	wipo.ent
	mathml2.dtd
	mathml2-gname-1.mod
	isoamsa.ent
	isoamsb.ent
	isoamsc.ent
	isoamsn.ent
	isoamso.ent
	isoamsr.ent
	isogrk3.ent
	isomfrk.ent
	isomopf.ent
	isomscr.ent
	isotech.ent
	isobox.ent
	isocyr1.ent
	isocyr2.ent
	isodia.ent
	isolat1.ent
	isolat2.ent
	isonum.ent
	isopub.ent
	mmlextra.ent
	mmlalias.ent
	soextblx.dtd
	Naup0487usa1-01.TIF
	Naup0487usa1-02.TIF
	Naup0487usa1-03.TIF
	Naup0487usa1-04a.TIF
	Naup0487usa1-04b.TIF
	Naup0487usa1-04c.TIF
	Naup0487usa1-04d.TIF
	Naup0487usa1-04e.TIF
	Naup0487usa1-04f.TIF
	Naup0487usa1-05.TIF
us-declaration	NAUP0487-1DEC1.tif
us-declaration	NAUP0487-1DEC2.tif
Comments	